Product information

Soldering paste ISO-Flux® "EL"



Description of product :	Soldering paste ISO-FLUX [®] "EL"	
Description of standard :	DIN EN 29454-1, 1.1.3.C (DIN 8511, F-SW 32)	
Condition :	pasty	
Chemical composition :	No-Clean-flux on a basis of modified colophony in high boiling solvents with additives of organic, halide-free combinations.	
Application :	This flux is suitable for all soldering applications in the field of electronics.	
	It distinguishes itself through its temperature resistance and its high solids content.	
	ISO-Flux® "EL" is very suitable for solder or tinning works, which have to be carried out under high solder temperatures and long soldering times.	
<u>Physical data</u> :	Density (20°C) Melting point Solids content Halide content Colour E-corrosion	1,100 g/cm ³ approx. 60°C 93,0 % no halide amber none
Security advices :	We refer to the corresponding EU-Safety data sheet.	
Removal of the residues after soldering :	The flux residues do not provoke after soldering a corrosion of nonferrous metals and may therefore remain on the soldering joint (corrosion inspection of the flux residues according DIN 8516 respectively DIN 8527-1). We recommend for the cleaning our aqueous alkaline cleaner ISO-Clean-cleaning concentrate.	
Form of delivery :	5, 10, 30 ccm cartridges 100 g tins Other bottle sizes are deliverable on request.	
Advice :	Other fluxes in liquid form or form of paste are available.	
	Please do not hesitate to contact us for further information.	

All information about our products are the result of our long-standing experience, which we would like to pass on to our customers. Since we do not have any influence on the application with our products, please see the warranty claims in our conditions of sale because our liability is limited.